

# SEMICON® EUROPA

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## Entegris



A. Amade  
President, EMEA Region  
Entegris, Moirans, France

### Biography

Mr. Amade joined Entegris in 1995 as an application engineer in its semiconductor business. Today, he is the President of the Europe and Middle East (EMEA) region as well as the VP of sales for the Microcontamination Control division focused primarily on growing the semiconductor business in North America, Europe and the Middle East through market strategies and the management of sales. For more than 25 years, Mr. Amade has held leadership positions at Entegris in gas microcontamination market management, strategic account management, and regional sales management. Mr. Amade has a degree in Chemical Engineering from ENS Chimie Lille and is a member of the SEMI Electronic Materials Group, the Global Automotive Advisory Council for Europe (GAAC) and the Platform for Automotive Semiconductor Requirements Along the Supply Chain (PASRASC).

## SiC: Paving the way for Sustainable Mobility



M. Ruhnau  
Manager  
Porsche Consulting S.A.S., Paris, France

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### Abstract

Power transistors based on silicon carbide (SiC) technology will play an important role in a wide range of industries in the context of electrification and decarbonization. For the automotive industry, with the shift to battery-electric vehicles in many regions, SiC will be an important technical lever to improve charging performance and efficiency, and thus range. There are also weight and packaging benefits to consider. However, as the maturity of SiC technology is still relatively low compared to mature silicon-based products,

the semiconductor industry, as well as Tier-1s and OEMs, need to address three main challenges. First, unit costs must be reduced to penetrate volume segments and make the technical benefits widely available. Second, automotive quality requirements are high, especially when considering the higher mileage mission profiles of future vehicles. Third, global capacity must keep pace with rapidly growing global demand. By addressing these three levers, OEMs, Tier-1s and the semiconductor industry can make the most of SiC technology and pave the way for a sustainable automotive future.

**Biography**

Since 2019: Porsche Consulting Germany and France

Manager with competence focus semiconductor technology, product strategy and development, product cost optimization, design to cost, cost reduction and profitability programs

## The Role of SiC in E-Mobility



R. Bornefeld  
Senior Vice President Business Line and  
Engineering Power Semiconductors and Modules  
Robert Bosch GmbH, Reutlingen, Germany



### Abstract

The fast adoption of battery electric vehicles (BEVs) boosts the use of wide bandgap semiconductor materials. Silicon carbide has become tantamount to electro-mobility due to its superior performance in improving efficiency of electric drivetrains. However, it still has a higher cost than conventional silicon-based technology. This presentation will focus on efficiency and affordability aspects. We will go through the latest SiC innovations in material development, device structures and drivetrain concepts, and show how, all put together, enable not only efficient but most importantly affordable electrification from an end user perspective.

### Biography

Ralf Bornefeld is Senior Vice President with responsibility for business line and engineering of Power Semiconductors & Modules at Bosch. He joined Bosch in November 2019. Before he held various management positions at Infineon Technologies AG: senior director technology in frontend production from 2005-2008, senior director engineering of automotive sensors until 2011 and finally vice president and general manager business line automotive sensors. Ralf started his career at Elmos Semiconductor in 1992 as a technology development engineer. Afterwards he took several management positions until end of 2004, mostly serving as vice president of R&D and eventually as vice president of business line microsystems. Ralf Bornefeld was born in Schalksmuehle, Germany, in 1964. He graduated with a degree in Electrical Engineering from Technical University of Dortmund in 1992.

## Topic Coming Soon

The Soitec logo features the word "soitec" in a lowercase, sans-serif font. The letter "o" is replaced by a stylized graphic consisting of a blue circle on the left and a green leaf-like shape on the right.

E. Sabonnadière  
SVP Division Automotive & Industrial  
Soitec, Grenoble, France

The Soitec logo, identical to the one above, featuring the word "soitec" with a stylized "o" composed of a blue circle and a green leaf shape.

### Abstract

Coming Soon

### Biography

Since July 2021, Mr Sabonnadiere is Senior Vice-President of the Division Automotive & Industrial of Soitec. He is also in charge of the Strategic Program SiC.

From September 2017 to July 2021, Mr Sabonnadiere was CEO of CEA-Leti, one of the most innovative Labs in the industry of microelectronics and biotechnology, based in Grenoble (France).

Previous two years, Mr Sabonnadiere was CEO & Chairman of the Business Group Professional of Signify, former Philips Lighting (Amsterdam). From 2014 till 2016, he served as Senior Associate of MidCap Private Equity firm named Gimv (Paris, Antwerpen, Munich, Den Haag).

Previously in his career, Mr Sabonnadiere was CEO & Chairman of General Cable Europe & Africa (Barcelona). From 2005 till 2008, he was CEO of NKM Noell GmbH, the German branch of the group REEL. Mr Sabonnadiere was vice-president of the Distribution Transformers division of Alstom T&D for 5 years. He began his career in 1992 with Schneider Electric holding various positions including that of Managing Director of equipment units for 10 years.

Mr Sabonnadiere has a strong innovation and technological background combined with a successful business track record over decades and some key innovations adopted into the markets. With 30+ years of executive leadership of large operations, he produced high level performances of operating margins & results and generation of cashflow. He gained a sound experience of change management in large multi-cultural organizations to adapt to new markets conditions and dynamics in European and International environments. He designed and set-up ambitious strategic plans including some merge & acquisitions.

Mr Sabonnadiere believes in operational excellence, innovations in technology, talents management and enthusiasm in leadership. His sound experience in the European industry make him a highly knowledgeable and respectful Board member.

Mr Sabonnadiere obtained a PhD in physics (France), and an engineering degree in Information Technology (France). He holds an MBA (France)

Mr Sabonnadière is a fully qualified instructor at the ski school in Les Ménuires, and member of the Advisory board of IAC Consultant and Sparring Capital firm.

## Meeting the SiC Gold Rush with Entegris Capabilities



N. Mahadev  
Vice President, Advanced Planarization Solutions  
(APS) Division  
Entegris, Fremont, United States of America



### Abstract

Entegris leads the way in the design and manufacturing of dedicated SiC consumables, including CMP slurries, post CMP cleans, and pads. Our products are meticulously engineered for high-volume production, catering to the growing demand in the industry.

Our versatile products can be utilized across a wide range of new and existing OEM tools, such as single, double, and batch polishing equipment. By incorporating our slurries, these tools experience improved thruput efficiencies while simultaneously reducing wafer level defects and scratches.

Post CMP cleaning of wafers is of utmost importance, ensuring the removal of particles and metal contaminants before the epitaxial process. Our post CMP cleans are specifically developed to address this challenge while maintaining the performance of CMP pads and tool sets through effective cleaning solutions. Lastly, Entegris possesses cutting-edge cleanroom facilities, enabling us to conduct in-depth studies, analysis, and testing of pad/slurry interactions. This capability allows us to develop next-generation slurries and cleans, particularly as the industry transitions from 6" to 8" wafer sizes.

The focus of this presentation is to showcase compelling data on the performance of Entegris' SiC consumables across various toolsets, addressing both current and future industry requirements.

### Biography

Niraj Mahadev is an esteemed professional with a proven track record as a leader in the semiconductor industry since 1999. With extensive experience in the TDK Group of Companies, he has successfully held diverse roles in multiple countries across Southeast Asia and the USA. Throughout his career, Niraj has excelled in research and development (RD), new product introduction (NPI), yield optimization, and operations management. Notably, he demonstrated exceptional leadership skills while overseeing a large-scale manufacturing facility. Additionally, Niraj served as the managing director at BASF MicroChemicals, where he exhibited expertise in managing PCMP cleans and polishing/lapping slurries for the processes within the Hard Disk Drive Industry.

Niraj Mahadev's career has been marked by remarkable achievements and notable milestones. His contributions have been instrumental in driving industry advancements, including the successful adoption of the first Apple iPod hard disk drive. He also orchestrated the seamless transfer of high-volume manufacturing for hard-drive products from the United States to Singapore, optimizing operational efficiency and global supply chains. His impactful career highlights his ability to lead and deliver groundbreaking solutions in the semiconductor and storage industries.

Within Entegris, Niraj Mahadev leverages his wealth of experience and deep-rooted passion to drive advancements in the realm of advanced planarization solutions. His primary objective revolves around the development of specialty chemical products that seamlessly integrate chemistry and processes. By doing so, he aims to tackle the persistent challenges of enhancing performance, yield, and reliability in the storage, optical, and semiconductor industries. Through his dedication and expertise, Niraj contributes to shaping the future of these sectors by spearheading innovative solutions that optimize processes and elevate overall industry standards.